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Efficient Organization of Digital Periphery to Support Integer Datatype for Memristor-based CIM

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Abstract—Von Neumann-based architectures suffer from costly communication between CPU and memory. This communication imposes several orders of magnitude more power and performance overheads compared to the arithmetic operations performed by the processor. This overhead becomes critical for applications that require processing a large amount of data. Computation-in-Memory (CIM) leveraging memristor devices in the crossbar structure offers a potential solution to tackle this challenge. However, support for the integer data type is lacking in CIM approaches as most solutions operate on a single/few bits only. This paper proposes a new organization of the periphery (next to memristor crossbar) to compute matrix-matrix multiplication (MMM) at the tile level. More precisely, the analog additions performed in the crossbar is complemented with additions performed in the digital periphery. In this mixed analog-digital system, digital additions are performed in a way that only the minimum size of adders are required - this is to reduce the latency of the digital periphery as much as possible. In addition, the design is customized to the number of ADCs as well as datatype sizes to support different possible scenarios. The results show that our organization reduces energy and latency up to 50× and 3×, respectively, compared to the reference design.

I. INTRODUCTION

Big data applications such as neural networks and databases are being widely used in different domains. These applications require processing of large amounts of data that is usually located far away from the processing units. Consequently, the transport of data between the processing unit(s) and the memory leads to huge energy consumption and long latencies. This greatly diminishes the usefulness of von Neumann computers (to process the data) [1]–[3]. A solution to overcome this is to employ the Computation-in-Memory (CIM) approach that proposes the utilization of (new) technologies that allows for both storage and computing within the same (storage) structure. Such technologies include: resistive RAM (ReRAM) [4], phase-change memory (PCM) [5], and spin-transfer torque magnetic RAM (STT-RAM) [6]. Furthermore, they provide additional benefits such as high density, near-zero standby power, and non-volatility [7]. Although the memory crossbars built from these devices are usually low power, the peripheral circuits needed to control the crossbar can completely alleviate the gains. As an example, many applications such as Neural Networks (NNs) and Convolutional Neural Networks (CNN) at least require to integer (number) computations. However, since only limited levels can be stored in one memristor cell, the (bit-)vector representing the number should be distributed over multiple cells, which requires some extra processing outside the crossbar to get a meaningful result. Therefore, great care must be taken in the design of these peripheral circuits to really deliver efficient in-memory computing systems.

Recent researches in the field of CIM can be categorized as follows. First, the majority of researchers are focusing on improving device characteristics such as performance, energy, and endurance considering different technologies [8], [9]. Second, some works investigate different ways to perform computation inside the crossbar [10]–[12]. Third, researchers are focusing specifically on mapping NN and CNN applications to memristor crossbars to serve as accelerators for these applications. [13]–[15]. However, no implementation details are provided how to deal with the post-processing of integer datatypes in the digital peripheral circuits surrounding the crossbar. Until now and to the best of our knowledge, only a single publication has addressed this challenge [16].

In this work, the authors perform the first stage of matrix-matrix multiplication in the crossbar and continue performing the remaining additions in the analog domain through use of analog buffering and accumulation units. The advantage is the reduction of analog-to-digital (ACD) operations, but at the cost of a higher-precision ADC unit. This is worsened when considering larger crossbars or larger integer word sizes. Moreover, analog computing is more fragile to noise compared to digital computing, which is critical for applications that require high accuracy.

In this paper, in order to support the unsigned integer datatype, we propose a new adder structure in the periphery next to the memory crossbar. The proposed design utilizes minimum-sized adders customized based on technology-driven restrictions, e.g., the number of active crossbar rows per addition. Furthermore, our approach takes into account the number of ADCs employed by the crossbar. Finally, the structure is not restricted to a single fixed integer word size and can flexibly support different word sizes without hardware changes. The contributions of this paper are the following:

- a new design is proposed to aid in-memory crossbar to perform additions targeting integer matrix-matrix multiplication (MMM).
- the proposed design is customizable in order to support a varying number of ADCs.
- the proposed design is evaluated in terms of energy and performance using our in-house simulator configured with the parameters defined by technology and synthesized designs.
The remainder of this paper is organized as follows. In Section II, the state-of-the-art which is categorized in different levels of CIM abstraction will be explained briefly. In addition, the way that analog computation performed in the memristor crossbar is described briefly. Section III presents the organization of the addition unit. In Section IV, the evaluation model and the experimental results will be discussed. Finally, Section V concludes the paper.

II. BACKGROUND

A. Memristor devices

Memristors are devices that could achieve multiple distinct resistive levels; in the case of 2 resistive levels – High or Low – either of these states can represent one of the binary values ‘0’ or ‘1’. Once the device obtains either of the states, it would be able to keep its state for a relatively long period of time without consuming energy, therefore, memristors are considered as non-volatile memories (NVMs). Switching a device state from one state to the other can be performed in either a unipolar or a bipolar manner; in unipolar switching, the specific values of voltage (or current) are used to make the device to switch and in the bipolar switching, different polarity of voltage (or current) needs to be applied to the device in order to switch. To read the data from memristive devices, a signal (voltage or current) is applied to the cell and the value of the output signal determines the data stored in a cell. The read signal must be small to prevent the cell from being disturbed. Memristors can be used in a crossbar network with a structure of 1T1R. Fig 1 shows the I-V curve of the memristor which is a pinched hysteresis under sinusoid input [17], a crossbar structure, and bipolar switching.

B. Memristor-based computation circuits

Computation-in-Memory (CIM) is an approach to overcome the memory wall problem by reducing the distance between data and computation within the same memory array by exploiting new memory technologies. Within this approach, we can clearly distinguish two directions by looking at where the results of the computation is being produced. CIM-A is used to denote when the results are produced within the memory array and CIM-P is used to denote when the results are produced in the periphery [18]. A brief description of CIM-A and CIM-P are presented in the following:

- **CIM-A**: The main advantage of CIM-A is the achievable high bandwidth of computations as data is stored and computed within the same memory array. However, storing the results in the same memory also means an increased amount of write operations within the array. The latter is detrimental due to the limited endurance of current-day NVMs. Moreover, performing computations within the array requires significant modifications to the (analog) array as well as the (digital) periphery. [19], [20] are examples of CIM-A approaches.

- **CIM-P**: In comparison to CIM-A, the computational bandwidth of CIM-P approaches is reduced – still, it is much higher than approaches that need to transfer the data out of the memory tile. However, as less writes to the memory array are needed, the endurance issue can be avoided. Furthermore, the memory array requires far fewer modifications. Moreover, changes in the (digital) periphery are easier to implement.

C. In-memory architecture

A few promising studies design application-specific accelerators enjoying CIM concept mostly for NNs. ISAAC [13] designs an accelerator for convolutional neural networks using ReRAM devices to exploit the efficiency of in-memory computing. PRIME [14] targets NN as an application and proposes an architecture that enables the authors to configure some portion of memory as a computation unit according to the requirements. To control the memristor-based memory, new in-memory instructions were proposed [15] based on the SIMD execution model. However, none of the aforementioned works provide implementation details to show how to support integer MMM in the tile-level.

To the best of our knowledge, CASCADE [16] is the only work providing implementation details to support integer numbers for MMM. In this work, by employing analog buffers, some parts of partial sum and accumulation happen in an analog way, which helps to reduce the number of ADC conversions. Although the number of conversions are decreased leveraging this approach, the resolution of ADCs should be increased, which imposes energy overhead that grows exponentially [13]. Furthermore, as the number of columns contribute to the analog partial sum and accumulation increased, the relative difference between voltage/current levels of output reduced, which requires more complex ADCs. Equations 1 and 2 demonstrate a set of equivalent resistance for one column as well as several columns when they are attached to each other, respectively.

\[
R_{eq} \in L = \{R_{off}, R_{on}, R_{on}/2, \ldots, R_{on}/n\} \\
n : number of crossbar rows
\]

\[
R_{eq} \in L = \{R_{off}, R_{on}, R_{on}/2, \ldots, R_{on}/(m \times n)\} \\
n : number of crossbar rows \\
m : number of connected columns
\]
In the following, we will utilize a simplified MMM example in order to highlight the mapping of the multiplicands in the crossbar. We assume that the calculation of a single element \( z_1 \) in the result matrix is as follows: \( a*b + m*c + p \). All values are assumed to be 3 bits in this example. The values a, b, and c are the multipliers and j, m, and p are the multiplicands. Furthermore, we assume that the multiplicands are needed again in other MMM operations and this is the reason to map them into the crossbar - this avoids multiple writes to the crossbar. Figure 2 depicts the multiplication (for \( z_1 \)) written out in full and the mapping of the multiplicands to the crossbar assuming that each cell can only store a single bit. It should be clear from the figure that we first multiply the zero-th bit of the multipliers with the multiplicands and sum them up as they pertain to the same weight (2^0) in the final result. The same multiplicands (indicated in yellow) are needed again when multiplying them with higher-order multiplier bits. In case the crossbar has more columns, the multiplicands k and l can also be mapped. Otherwise, different wires are needed to map those multiplicands.

### A. Integer data mapping

According to the equations, the relative difference between resistance levels is reduced more as the datatype size increases. In addition, despite the reference architectures that can perform precise MMM, it was assumed that approximation can be tolerated to be able to remove ADCs for some columns. Finally, besides the complexity for placement and routing of many analog buffers considered in the periphery, the maximum current that can be tolerated according to the technology constraint has to be taken into account.

III. OVERALL ADDITION UNIT ORGANIZATION

In this section, the proposed periphery design to support integer MMM is explained. First, the mapping of data to the crossbar is discussed. Subsequently, the digital processing which has to be performed on the output of the crossbar, to prepare the final result of MMM, is presented. This processing has to be performed in several steps, which depends on the number and precision of ADCs used in the CIM tile. We elaborate on different scenarios to see what changes are required for each.

### B. Proposed organization for addition units

Our proposed adder design clearly distinguishes threeadder stages to perform the MMM operation. The design considerations of each stage are described in the following.

#### Stage 1: Adding one column

In this stage, the addition within a single column is performed - indicated by the orange-brown arrow(s) in Figure 3. Essentially, the addition in this stage is performed in an analog manner - using Kirchhoff’s Law - if and only if (1) the analog-to-digital converter (ADC) is capable of distinguishing between all the possible current levels and (2) all the necessary rows (related to the multiplier) can be activated at the same time - this is dictated by the utilized technology. If either (or both) of the mentioned conditions is (are) not met, the addition needs to be broken down to only adding those number of rows that can be supported by the ADC accuracy or technology. This means that the analog addition is only performed among a smaller number of rows and the resulting intermediate results need to be summed up together in the digital domain. The latter is depicted in Figure 4(b). It should be noted that the size of the digital adder here is determined by the largest possible results after all rows have been added - worst case: \( \log_2(rows) \). The result of this stage is the summation of all the terms related to one bit-position of the multiplier and one bit-position of the multiplicand.

#### Stage 2: Adding multiple columns

As the result of the first stage relates to the summation of only a single bit-position of the multiplicand, the second stage adds up all the terms (i.e., all bit positions) related to the multiplicand (multiplied with only one bit-position of the multiplier) - see blue box in Figure 3. In this stage, we are assuming that the multiple columns are sharing one ADC and that (for now) the integer word size (of multiplicands)
does not exceed this number. The first assumption is not a restriction as all operations described in this stage remain the same if assumption would not hold. The second assumption is a restriction as loosening it would require additional logic to combine the (intermediate) results. Since this would severely complicate the introduction of our approach at this stage, we defer it to a later section in this paper. The results of each column (see Figure 4(a)) relate to different weights of the multiplicand. Consequently, we can use the same adder (maximum size: \(\log_2(\text{rows})\)) to perform addition as long as each time the addition is performed, the intermediate result is shifted by one position. This means that the lowest significant bit, which is shifted out, can be stored in a temporary register \((R2_{\text{temp}})\). The higher order bits are stored in \((R1_{\text{temp}})\) - this register must be initialized to zero before the MMM operation is started. The aforementioned addition can be performed while the ADC is “scanning” the columns. The result of the second stage is a partial result of the MMM operation that relates to a single bit-position of the multiplier, e.g., \(a_0, b_0,\) and \(c_0\).

**Stage 3: Adding higher-order results**

In this stage, the partial sums related to different bit positions of the multiplier need to be summed up. This is depicted in Figure 4(c). The partial sums related to 0-th bit position of the multiplier (gray box) need to added to the partial sum of the 1-st bit position of the multiplier (blue box), and so on. Here, we can employ the same adder structure as described in stage 2 - see Figure 4(a). Only now, the adder and needed temporary registers are larger in size.

![Fig. 4: Required digital processing phases per ADC](image)

![Fig. 5: The overall organization required per ADC](image)

Figure 5 puts together all the hardware discussed before for each processing phase. Following is the generalized size of the registers used in the proposed organization. Clearly, the size of the adders is equal to their corresponding registers.

\[
R_0 = R_1 = R_2 = R_{1\text{temp}} = \log_2(\text{crossbar height}) + \log_2(\text{cell levels}) \tag{3}
\]

\[
R_{2\text{temp}} = R_{3\text{temp}} = \text{int size(multiplicand)} + \log_2(\text{crossbar height}) \tag{4}
\]

\[
R_{4\text{temp}} = \text{int size(multiplier)} + \text{int size(multiplicand)} + \log_2(\text{crossbar height}) \tag{5}
\]

What we discussed so far, was based on the assumption that the size of integer numbers stored in the crossbar matches to the number of columns shared an ADC. However, two other possible scenarios have to be considered. First, by increasing the number of ADCs, a number stored in the crossbar might be split and distributed over multiple ADCs. To clarify this further, Figure 6 illustrates this scenario in which 32-bit numbers distributed over 4 ADCs. Accordingly, to obtain the final result, the values stored in all the \(R_{4\text{temp}}\) registers, employed for each ADC, have to be summed up. Although more hardware is required as the number of ADCs increased, the length of the registers and adders employed for processes per ADC are decreased.

**IV. EVALUATION AND DISCUSSION**

In this section, we will evaluate our design against a reference design. First, we introduce the reference design and the target technology. Subsequently, the results regarding the performance and energy of our proposed design will be discussed.

**A. Experimental setup**

Reference architecture. In the reference design, we assume that a single adder to perform accumulation between shared columns and different bit positions of the multiplier are connected to each ADC. The size of the adder is fixed and must be chosen based on the largest possible value resulting from the MMM - it is specified in Equation 6. This means that the value produced by the ADC is merely an intermediate result.
that must be summed up into the accumulator - remember
that only a single bit of the multiplier is multiplied with the
multiplicand and each ADC read-out corresponds only to a
single bit-position of the multiplicand. Due to the previously
stated manner of summation, the intermediate results must
be shifted by the correct number of positions (based on the
bit-positions of the multiplier and the multiplicand) before entering the adder.

\[ \text{Adder size} = \int size(\text{multiplier}) + \int size(\text{multiplicand}) + \log_2(\text{crossbar height}) \]  

In order to evaluate our design (against the reference
design), we have synthesized both designs using Cadence
Genus with standard cell 90nm UMC library to generate
latency and energy numbers. The latency and energy numbers
related to the crossbar (assumed to use ReRAM for now)
and (SAR) ADCs are taken from [21] and [22], respectively.
These numbers are summarized in Table I and more detail
information about ReRAM device can be found in [21].

Subsequently, these numbers serve as input to our in-house tile
simulator. Our simulator is capable of executing programs and
capturing the behavior of the crossbar and peripheral circuit.

As a benchmark, we have chosen the linear-algebra kernel
“gemm” from the Polybench/C benchmark suite. In this kernel,
first the multiplicands are written into the crossbar and then the actual multiplication is performed. We utilized our in-house
developed compiler to translate the gemm benchmark into a
sequence of in-memory instructions controlling the crossbar
and its peripheral circuits.

**B. Experimental results**

Reading data from the crossbar’s columns (read out phase)
is inherently slow mainly because of the shared ADC between
multiple columns and can be considered as the bottleneck
of the architecture. However, as the size of adder grows, its
latency can be dominant over the latency imposed by ADC.

Considering the proposed design in our experiment, since the
crossbar has 256 rows, the maximum size of the first two
adders (see Figure 5) is always 8-bit regardless of datatype
size. Therefore, there is no extra overhead on the latency of
read out phase. Rather, in the reference design and according
to the Equation 6, the required size of adder is much larger.

Accordingly, considering a 1 ns latency for the ADC, as
the size of adder increased more than 8-bit, it becomes the
bottleneck of the system and makes the read out phase more
costly.

Figure 7 depicts the execution time of the kernel (including
writing to the crossbar). In this experiment, we assume that the
size of the integer numbers matches the number of columns
shared by one ADC. According to the figure, the size of the
first two adders for the proposed design are always constant (here 8-bit). Rather, as the datatype size increases, a larger adder has to be employed for the reference design. Considering an 8-bit datatype size in Figure 7, a 24-bit adder has to be used for the reference design, which imposes a 3 times bigger latency than an ADC. However, due to the abundance of ADCs, the entire readout phase is not the bottleneck of the system (see Table I for the crossbar latency). Therefore, there is no performance improvement at this point. Figure 8 shows the energy improvement achieved by the proposed design. Although the number of computations is always the same, they are performed with smaller adders, which has a positive impact on the energy consumption of the addition unit. Finally, the impact of the number of ADCs on the execution time and energy of the addition unit using 32-bit datatype size are presented in Figure 9. As the number of ADCs increased, the performance is improved. In addition, although more adders are employed (see Figure 6), their size is decreased, which leads to less energy consumption.

V. CONCLUSION

In this paper, we proposed a new organization for memristor-based crossbar periphery to support integer matrix-matrix multiplication at the tile level. Besides to the analog additions in the crossbar, digital additions are performed in a way that minimum adder sizes are required. The results show that using the proposed design, performance improved up to 3x and energy reduced by 50x compared to the reference design.

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